

SE720

PNP Low VCEsat Transistor with N-Channel Trench MOSFET

Revision: A

General Description

Combination of PNP low VCEsat Breakthrough in Small Signal transistor and N-Channel Trench MOSFET

- Simple Drive Requirement
- Small Package Outline
- Surface Mount Device

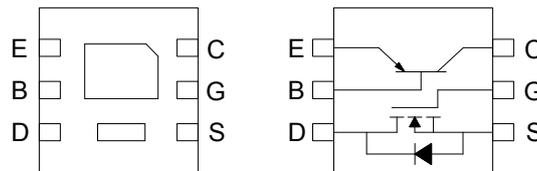
Features

For a single MOSFET

- $V_{DS} = 20V$
- $R_{DS(ON)} = 500m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} = 900m\Omega @ V_{GS}=2.5V$

Pin configurations

See Diagram below



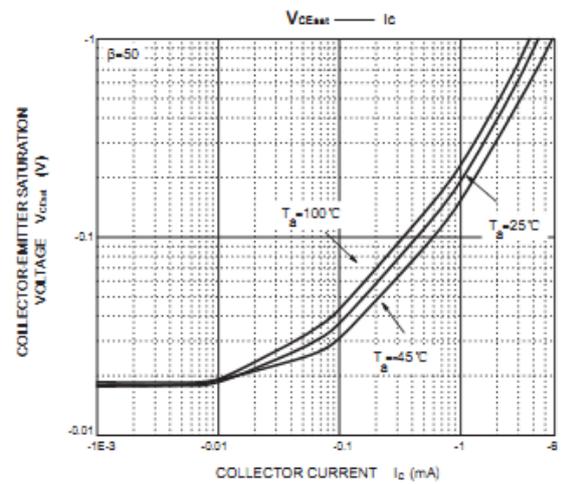
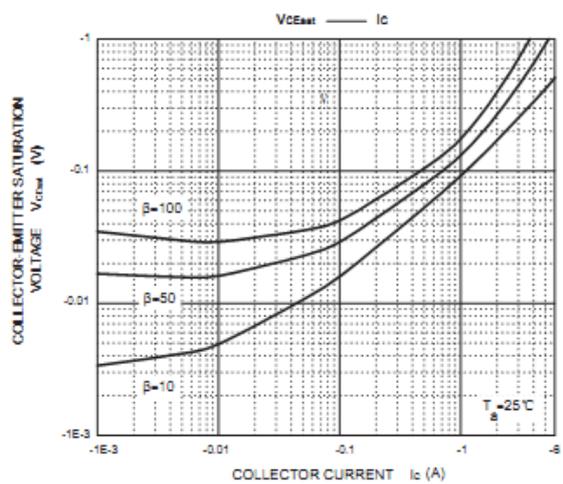
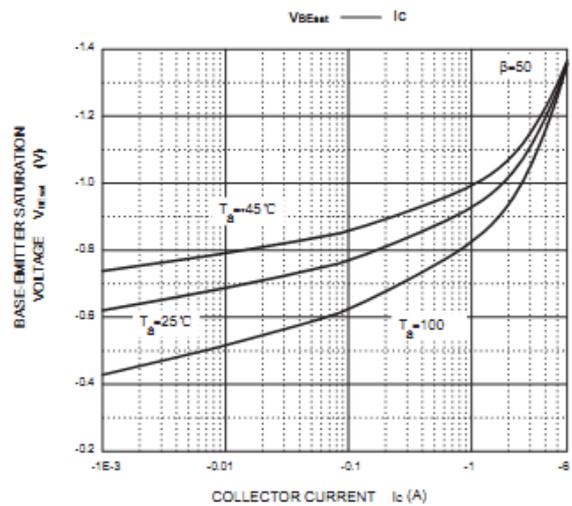
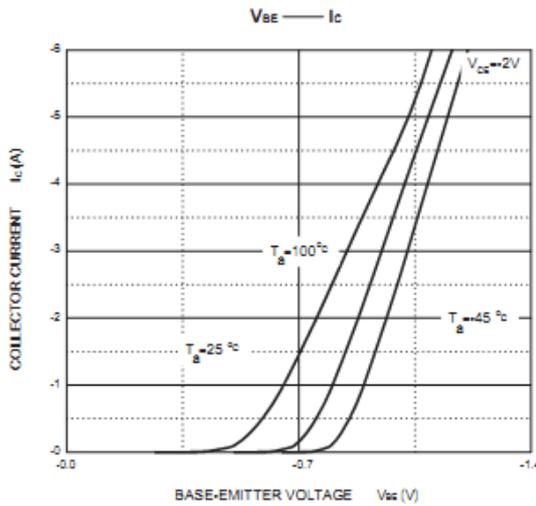
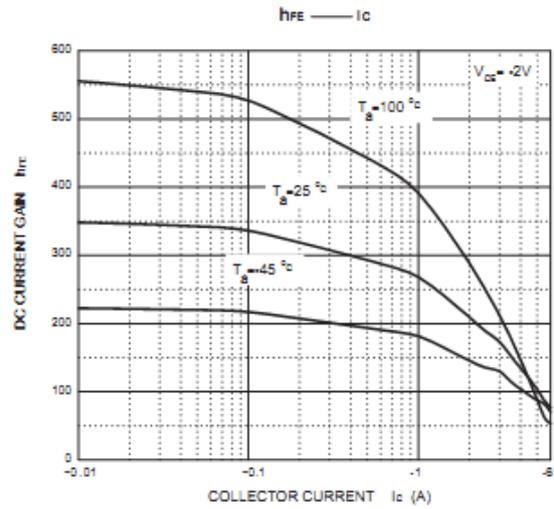
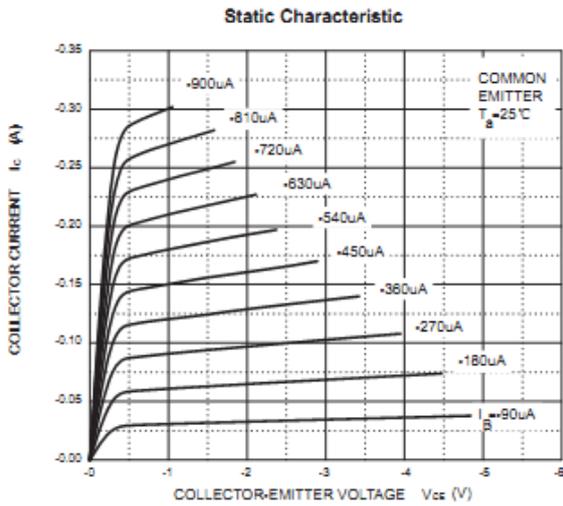
Absolute Maximum Ratings

Parameter	Symbol	Rating	Units	
Drain-Source Voltage (MOSFET)	V_{DS}	20	V	
Collector-Emitter breakdown voltage (PNP transistor)	BV_{CEO}	-25	V	
Gate-Source Voltage (MOSFET)	V_{GS}	± 12	V	
Collector-Base breakdown voltage (PNP transistor)	V_{CB}	-25	V	
Emitter-Base breakdown voltage (PNP transistor)		-6	V	
Drain Current(MOSFET)	Continuous	0.3	A	
	Pulsed	0.8		
Total Power Dissipation	@ $T_A=25^\circ C$	P_D	2	W
Operating Junction Temperature Range	T_J		-55 to 150	$^\circ C$

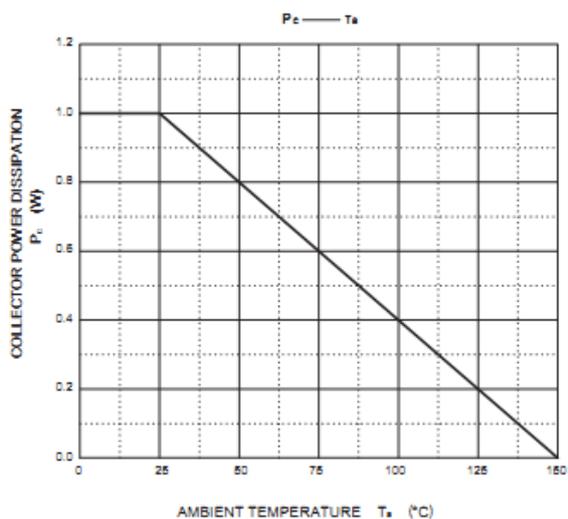
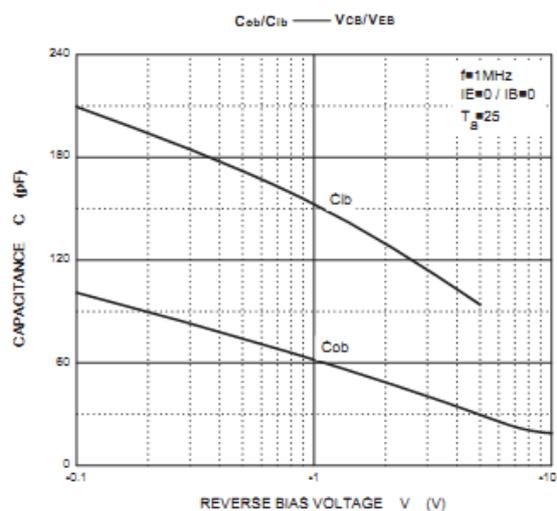
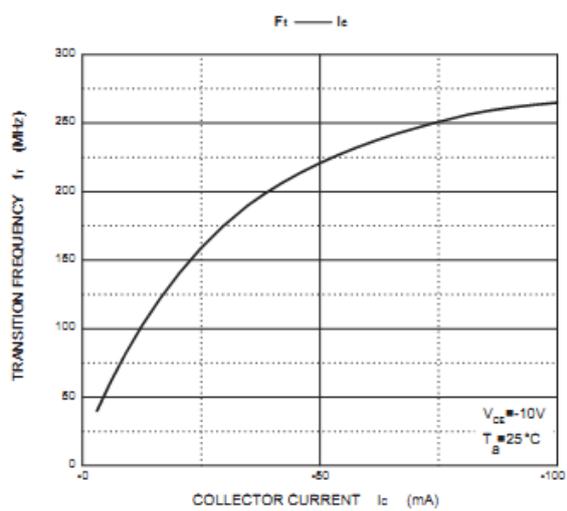
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Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0 V	20			V
I _{DSS}	Drain to Source Leakage Current	V _{DS} = 20V, V _{GS} =0V			1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =8V			10	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA			2.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V, I _D =0.1A	-	500	750	mΩ
		V _{GS} =2.5V, I _D =0.1A		900	1000	mΩ
V _{SD}	Diode Forward Voltage	I _{SD} =150mA, V _{GS} =0V		0.68	1.2	V
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =16V, f=200kHz		120		pF
C _{oss}	Output Capacitance			40		pF
C _{rss}	Reverse Transfer Capacitance			25		pF
PNP Transistor Specifications						
V _{(BR)CBO}	Collector-base breakdown Voltage	I _C =-50μA, I _E =0	-40			V
V _{(BR)CEO}	Collector-emitter breakdown Voltage	I _C =-1mA, I _B =0	-20			
V _{(BR)EBO}	Emitter-base breakdown Voltage	I _E =-50μA, I _C =0	-5			
I _{CBO}	Collector-base breakdown Current	V _{CB} =-40V, I _E =0			-200	μA
I _{EBO}	Emitter-base breakdown Current	V _{EB} =5V, I _C =0			-200	
h _{FE}	DC current gain	V _{CE} =-2, I _C =-500mA	100		300	
V _{CE(sat)}	Collector-emitter saturation voltage	I _C =-0.8A, I _B =-10mA		-320	-500	mV
Thermal Resistance						
Symbol	Parameter		Typ	Max		Units
R _{θJA}	Junction to Ambient At Steady State (MOSFET)		-	150		°C/W
R _{θJA}	Junction to Ambient At Steady State (PNP Transistor)			125		°C/W

Typical Characteristics

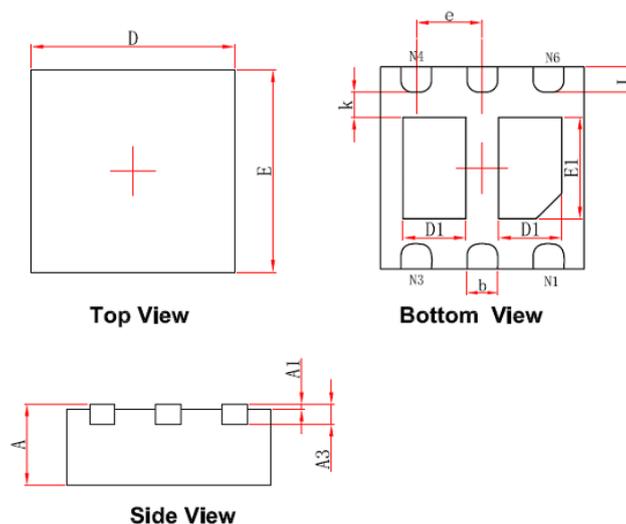


Typical Characteristics



Package Outline Dimension

DFN2X2X0.75



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	1.924	2.076	0.076	0.082
D1	0.520	0.720	0.020	0.028
E1	0.900	1.100	0.035	0.043
k	0.200MIN.		0.008MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.174	0.326	0.007	0.013

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